

BST-21503A 150g Top quality solder paste for LED BGA SMD PGA Top Sale Soldering Paste Flux Grease

Product Description:

100% Brand new and high quality!!

Rosin flux is used to facilitate soldering.

It cleans and prevents metal oxidation which allows solder to create strong, long lasting mechanical and electrical bonds.

It also acts as a wetting agent, increasing the flow of solder and the efficiency of the soldering process.

Perfect for mobile phones, PC cards and other sophisticated electronic chip-level flux welding.

Specifications:

Product:BST-21503A

Melting point:60°C

Weight: 150g/pc

PRODUCT DISPLAY



PRODUCT DETAILS



Name: Soldering Paste

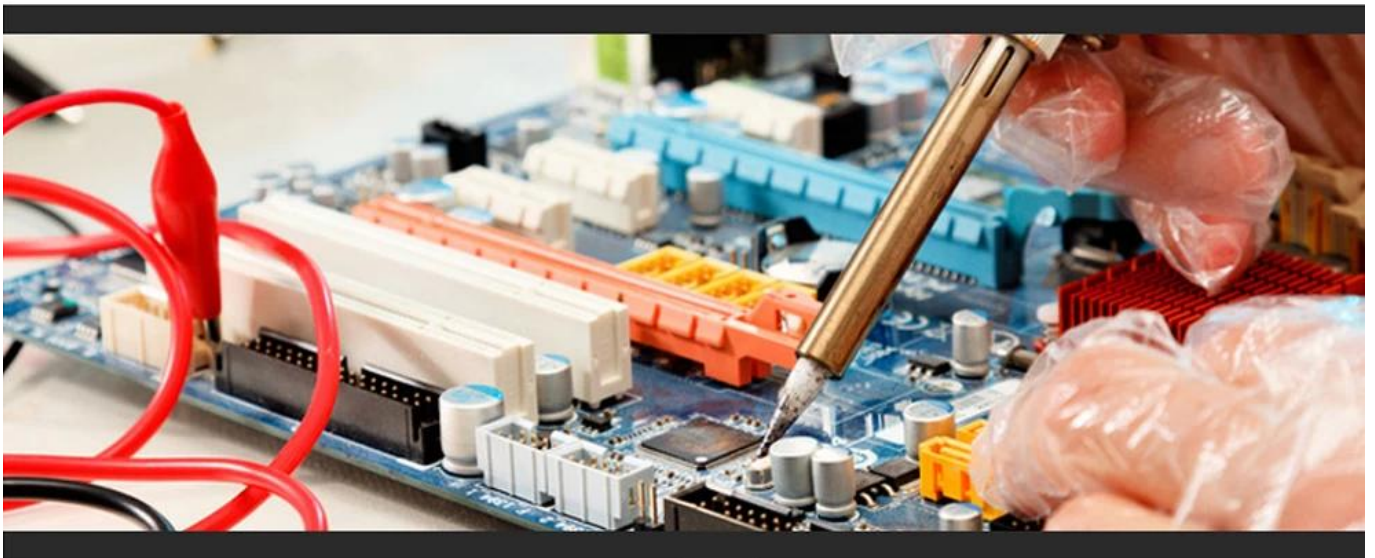
Size: $\Phi 80 \times 45\text{mm}$

Composition: Solder powder, resin

Model: BST-21503A

Weight: 100g

Melting point: 60°C





- ▲ Stable performance, Not volatile, long life cycle, the amount of province;
- ▲ Non-toxic non-irritating odor, the use of safe and reliable;
- ▲ The IC and PCB are not corrosive
- ▲ Its boiling point is only slightly higher than the melting point of solder.

Features: Solder melting at the time of soldering begins to boil endothermic vaporization, which can be maintained at this temperature using IC and PCB temperatures. In the demolition of the chip with a lot of solder paste, it melts fast, you can flow to the BGA chip below. Rosin is solid without solder paste convenient.

PRODUCT PHOTOGRAPH



